



Heraeus Copper Pastes for Hybrid Electronic Circuits

Heraeus Electronics offers a series of thick film pastes for production of hybrid microelectronic circuits where copper conductors will be utilized on alumina substrates. The products include copper conductors, through hole conductors, dielectrics, and overglazes which all can be fired in a nitrogen atmosphere furnace.

Key Benefits:

- Low cost base metal composition
- Solderable
- Wire bondable
- ENIG plateable
- Etchable
- Compatible dielectric and overglaze materials

